SPECIFICATION FOR APPROVAL

承认书

CUSTOMER					NUMBER			
客户名	称:				编	号:		
DESCRIPTION			N			QUAN	TITY	
	口口	名:	贴片共模滤波器			数	量:	
	PART	NO.				DATE		
	型	号:	BCCM1008-2-8017	T02		日	期:	
	CUSTO)MER F	PART NO.			NOTE		
	客户制	斗号:				注	解:	
					SIGNATURE 承认签章			
			APPROVED BY 核 准	Q. C. DEPT. 品 管	CHECKED BY 核 查		DRAWN BY 制作	
		1			1	- 1		I

深圳市惠尔德电子有限公司

SHENZHEN HUIERDE ELECTRONICS CO., LTD.

地址: 深圳市龙华区观澜街道福民福苑工业区二栋三楼

Tel: 13510325766

DC COMMON MODE FILTER

FEATURES

- A chip-type common mode filter for large current applications. Common mode impedance surpasses $800\,\Omega$ at 100MHz. Noise is greatly suppressed.
- *Capable of handling the highest current(up to 4.0A) of any chiptype common mode filter.
- 'Height and size have been considered , resulting in a compact and light-weight choke coil. Applicable for the miniaturization required to reduce the size and weight of portable equipment.
- *The products contain no lead and also support lead-free soldering.
- The product does not contain regulatde substances that are slated to be included in ROHS.



APPLICATIONS

Used for power line noise suppression for any electonic-devices
Used to counter adapter/battery line noise for relatively large electronic devices such as notebook PCs, stand-alone word processors, etc

TEMPERATURE RANGES

Operating	—40to+125℃	
Storage (After mount)	- 40to+125℃	

Part Number System

BCCM	1008	<u>-2</u>	<u>-801</u>	<u>T</u>	<u>02</u>
(<u>1</u>)	(2)	(3)	(4)	(5)	(6)

- ① Type:BCCM
- ② External Dimensions (L×W) (mm):10.0*8.0
- ③ Number of Lines: 2
- 4 Impedance: $801=800 \Omega$
- 5 Packing: Tape & Reel
- 6 Management Symbol:02

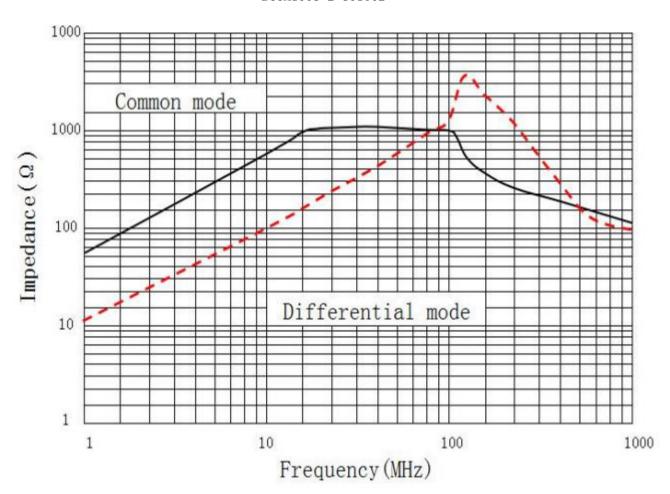
ELECTRICAL CHARACTERISTICS

Part No.	lmpedance (Ω)min[at 100MHz]			$\begin{array}{c} \text{Insulation resistance} \\ \text{(M}\Omega) \text{min} \end{array}$
BCCM1008-2-801T02	800	22	4	10

DC COMMON MODE FILTER

TYPICAL ELECTRICAL CHARACTERISTICS IMPEDANCE vs. FREQUENCY CHARACTERISTICS

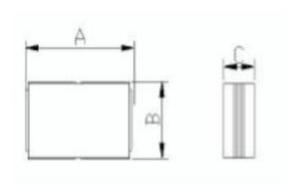
BCCM1008-2-801T02

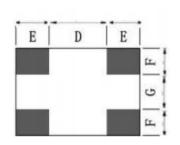


DC COMMON MODE FILTER

SHAPES AND DIMENSIONS/CIRCUIT DIAGRAM/RECOMMENDED PC BOARD PATTERN (REFLOW SOLDERING)

◆ Dimensions (mm)





UNIT: mm

 $A:10.2 \pm 0.5$

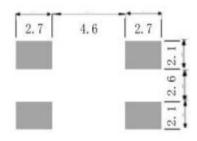
 $B:8.2\pm 0.5$

C:6.0 (MAX)

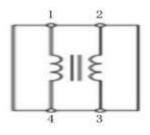
D:5.0 E:2.50

F:1.90 G:3.0

◆ Land Pattern(mm)



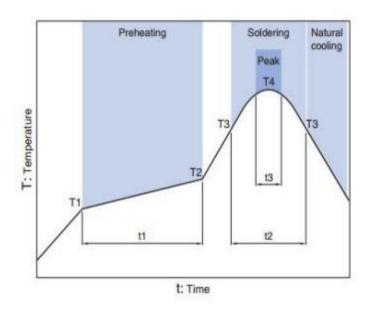
◆Schematics(Bottom)



No polarity

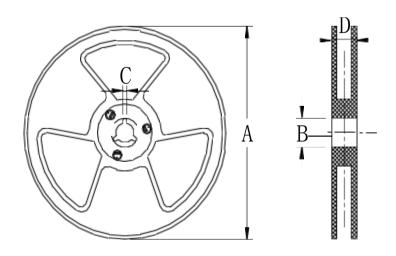
DC COMMON MODE FILTER

Recommended Reflow Temperature Curve



Preheating			Solderin	Soldering		Peak	
Temp.		Time	Temp.	Time	Temp.	Time	
T1	T2	tt	T3	t2	T4	t3	
150°C	180°C	60 to 120s	230°C	10 to 30s	245°C	5s	

Package size (mm)



Specs size	13"	7"
A	Ф 330±2.0	Φ178±2.0
В	Φ90	± 2 0
С	2 3	
D	21.5	